

PLCC Series

3528 0.06W PINK

Datasheet







Introduction:

Ultra high luminous efficacy, combined with the flexibility in design due to its slim and miniature size. PLCC LED Series are optimized to be used as lighting for building.

IDescription:

- · Best luminous and color uniformity.
- · Enables halogen and CDM replacement.
- · The article itself presents the actual color.

Feature and Benefits:

- · High luminous Intensity and high efficiency
- · Based on Red : AlGaInP technology
- · Wide viewing angle: 120°
- · Excellent performance and visibility
- · Suitable for all SMT assembly methods
- · IR reflow process compatible
- · Environmental friendly; RoHS compliance



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General Information

Ordering Code Format

	X1	:	X2	X3	3-X4	X5	5-X6	X7	'-X8
-	Гуре	Com	ponent	Se	ries	Wa	ttage	Co	olor
2	Emitter	Т	PLCC	03	3528	Y6	0.06W	PX	Pink

X9-X10	X11-X13	X14-X16
Internal code	PCB Board	Serial Number
18 -	000 -	



Absolute Maximum Ratings

Absolute maximum ratings $(T_a=25^{\circ}C)$

Parameter	Symbol	Value	Units
Forward Current	I _F	30	mA
Pulse Forward Current (tp<=100μs, Duty cycle=0.25)	I _{pulse}	100	mA
Reverse Current	\mathbf{I}_{R}	10	uA
Reverse Voltage	V_R	5	V
LED Junction Temperature	T_{J}	115	°C
Operating Temperature	-	-40 ~ +85	°C
Storage Temperature	-	-40 ~ +125	°C
ESD Sensitivity (HBM)	V_{B}	2,000	V
Soldering Temperature	T_{s}	Reflow Soldering : 255~260°C/10~30sec Manual Soldering : 350°C/3sec	

Notes:

- 1. Proper current derating must be observed to maintain junction temperature below the maximum at all time.
- 2. LEDs are not designed to be driven in reverse bias.

Characteristics

Parameter		Symbol	Value	Units
Viewing Angle	(Typ.)	2Θ _{1/2}	120	Degree
Forward Voltage	(Typ.)	$V_{\scriptscriptstyle F}$	3.4	V
Thermal resistance		-	40	°C/W
CRI		-	80	-
Target Color coordinate	(X) (Y)	-	0.384 0.321	-
JEDEC Moisture Sensitivity		-	Level 2a Floor Life Conditions: ≤30°C / 60% RH Soak Requirements(Standard) Time (hours): 120+1/-0 Conditions: 60°C / 60% RH	-

- $1.2\theta_{1/2}$ is the off-axis angle where the luminous intensity is half of the axial luminous intensity.
- 2. Color Rendering index CRI tolerance: ±2.



Luminous Flux Characteristic

Luminous Flux Characteristics, I_F=20mA and T_J=25°C

Color	Group	Min. Luminous Flux(lm)	Max. Luminous Flux(lm)	Forward Current(mA)	Order Code
	20	5.6	5.8		
	21	5.8	6.1		
	22	6.1	6.4		
Pink	23	6.4	6.7		2T03Y6PX18000001
	24	6.7	7.0	20	
	25	7.0	7.3		
	26	7.3	7.5		
	20	5.6	5.8		
Doop Bink	21	5.8	6.1		2T02V6DV19000002
Deep Pink	22	6.1	6.4	210316PX18	2T03Y6PX18000002
	23	6.4	6.7		

The luminous flux performance is guaranteed within published operating conditions. Edison Opto maintains a tolerance of $\pm 10\%$ on flux measurements.

Voltage Bin Structure

Group	Min. Voltage (V)	Max. Voltage (V)
VA1	2.8	2.9
VB1	2.9	3.0
VC1	3.0	3.1
VA2	3.1	3.2
VB2	3.2	3.3
VC2	3.3	3.4

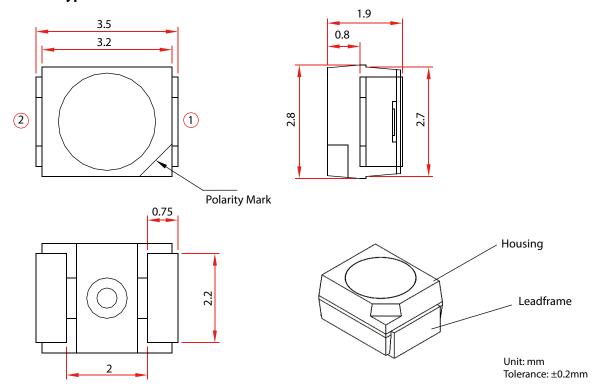
Note:

Forward voltage measurement allowance is \pm 0.06V.

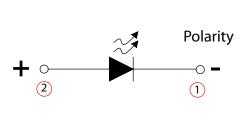


Mechanical Dimensions

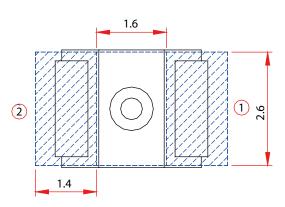
Emitter Type Dimension



Circuit



Solder Pad

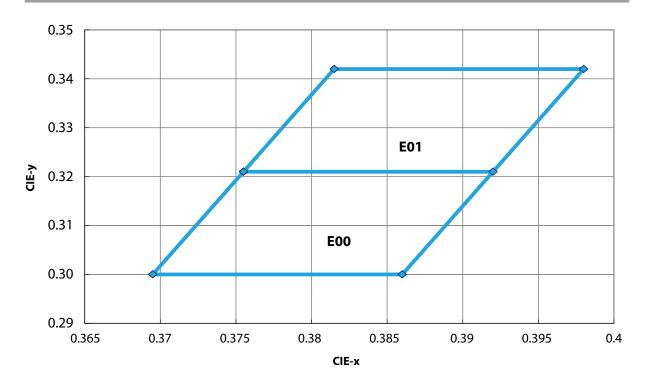


Notes:

- 1. All dimensions are measured in mm.
- 2. Tolerance : \pm 0.20 mm



Color BIN code (Pink)



Color Bin Structure

Pink Bin Coordinate

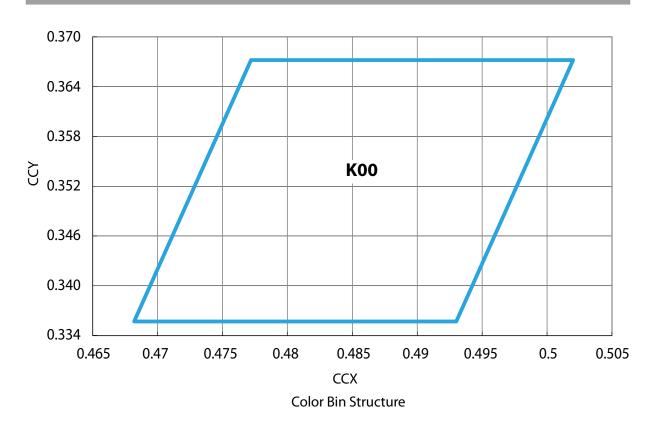
E	00	Ξ	01
Х	Υ	X	Υ
0.3755	0.3210	0.3755	0.321
0.3920	0.3210	0.3815	0.342
0.3695	0.3000	0.3980	0.3420
0.3860	0.3000	0.3920	0.3210

Note:

CIE_x/y tolerance: ±0.005



Color BIN code (Deep Pink)



Deep Pink Bin Coordinate

K00			
x	Υ		
0.4682	0.3357		
0.4772	0.3672		
0.5020	0.3672		
0.4930	0.3357		

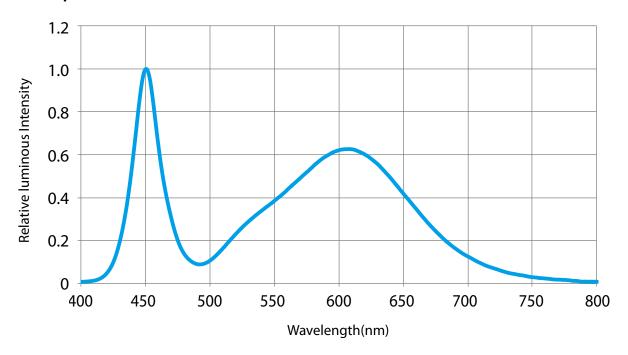
Note:

CIE_x/y tolerance: ±0.005

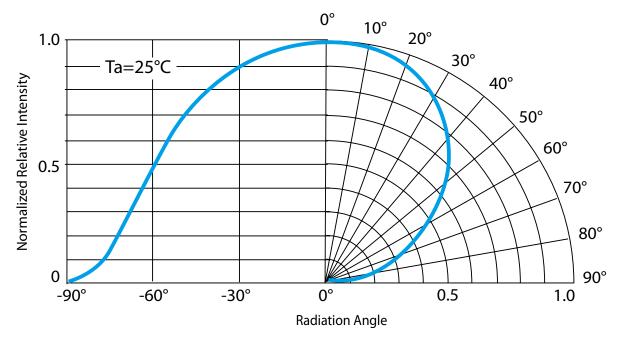


Characteristic Curve

Color Spectrum

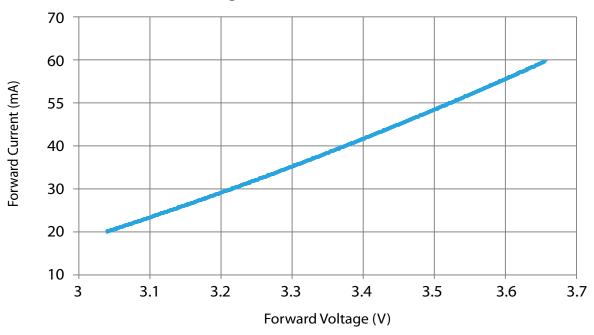


Beam Pattern

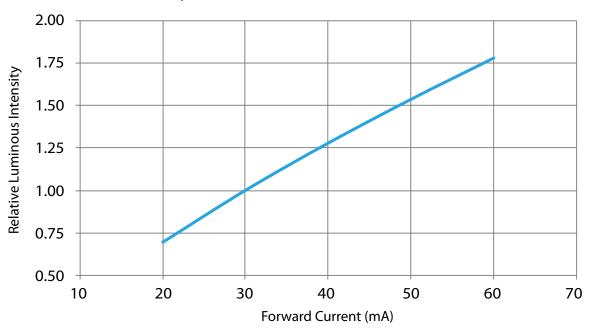




Forward Current vs. Forward Voltage

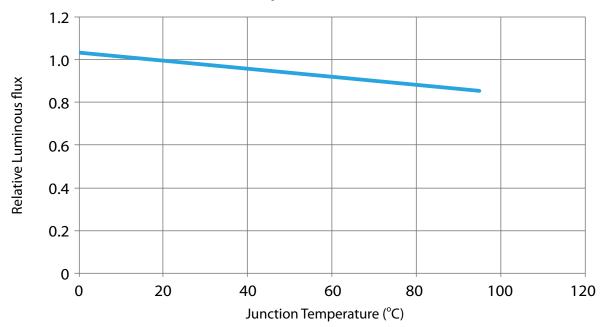


Relative Luminous Intensity vs. Forward Current

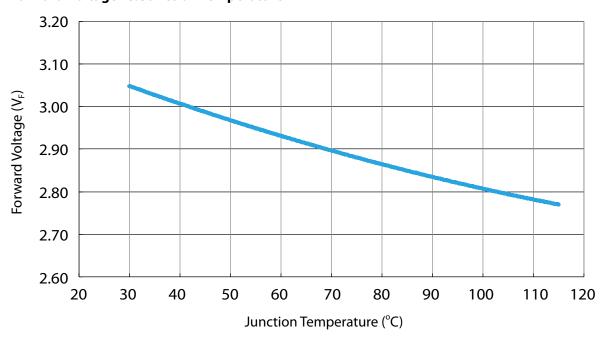




Relative Luminous Flux vs. Junction Temperature



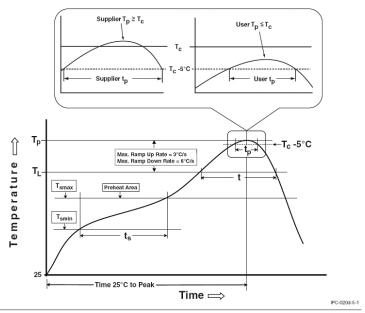
Forward Voltage vs. Junction Temperature





Reflow Profile

The following reflow profile is from IPC/JEDEC J-STD-020D which provided here for reference.



Reflow Profiles

Classification Reflow Profiles

Profile Feature	Pb-Free Assembly
Preheat & Soak Temperature min (Tsmin) Temperature max (Tsmax) Time (Tsmin to Tsmax) (ts)	150 °C 200 °C 60-120 seconds
Average ramp-up rate (Tsmax to Tp)	3 °C/second max.
Liquidous temperature (TL) Time at liquidous (tL)	217 °C 60-150 seconds
Peak package body temperature (Tp)*	255 °C ~260 °C *
Classification temperature (Tc)	260 °C
Time (tp)** within 5 °C of the specified classification temperature (Tc)	30** seconds
Average ramp-down rate (Tp to Tsmax)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.

Notes:

- 1. * Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.
- 2. ** Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.



Reliability

NO.	Test Item	Test Condition	Remark
1	Temperature Cycle	-40°C~100°C 30, 30, mins	100 Cycle
2	Thermal Shock	-40°C~100°C 15, 15 mins ≦ 10 sec	100 Cycle
3	Resistance to Soldering Heat	T _{SOL} =260°C, 30 sec	3 times
4	Moisture Resistance	25°C~65°C 90% RH 24 hrs / 1 cycle	10 Cycle
5	High-Temperature Storage	T _A =100°C	1,000 hrs
6	Humidity Heat Storage	T _A =85°C RH=85%	1,000 hrs
7	Low-Temperature Storage	T_A =-40°C	1,000 hrs
8	Operation Life test	25°C	1,000 hrs
9	High Temperature Operation Life test	85°C	1,000 hrs
10	High Humidity Heat Life Test	85°C, 85%RH	1,000 hrs
11	ON/OFF Test	30 sec ON, 30 sec OFF	1.5W times

Failure Criteria

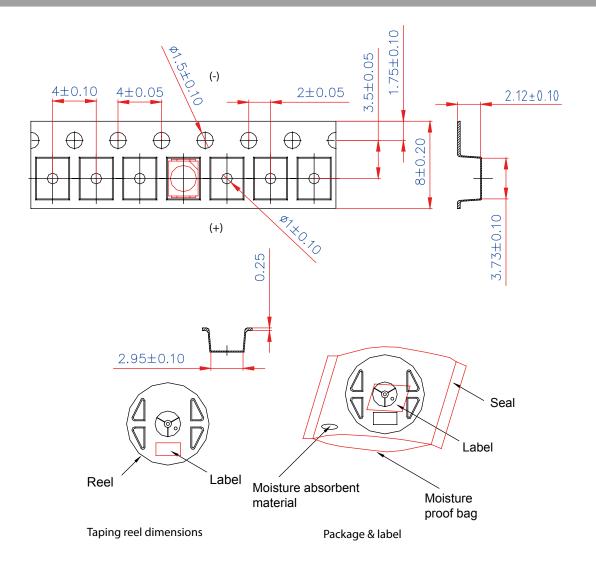
ltem	Criteria for Judgment			
iteiii	Min.	Max.		
Lumen Maintenance	85%	-		
∆ u'v'	-	0.006		
Forward Voltage	-	Initial Data x 1.1		
Reverse Current	-	10 μΑ		
Resistance to Soldering Heat	No dead lamps or visual damage			

Cautions

LED avoids being stored and lighted in the environment containing sulfur. Some materials, such as seals, printing ink, enclosure and adhesives, may contain sulfur, avoiding the exposure in acid or halogen environment.



Product Packaging Information



ltem	Quantity	Total	Dimensions(mm)	
Reel	2,000pcs	2,000pcs	R=178	
Вох	5 Reels	10,000pcs	240*235*67	
Carton	5 boxes	50,000pcs	353*254*256	
Starting with 50pcs empty, and 50pcs empty at the last				



Revision History

Versions	Description	Release Date
1	Establish order code information	2016/03/15
2	 Add Pink information Update Color BIN Code 	2016/08/19
3	Add the cautions of reliability	2017/06/22

About Edison Opto

Edison Opto is a leading manufacturer of high power LED and a solution provider experienced in LDMS. LDMS is an integrated program derived from the four essential technologies in LED lighting applications- Thermal Management, Electrical Scheme, Mechanical Refinement, Optical Optimization, to provide customer with various LED components and modules. More Information about the company and our products can be found at www.edison-opto.com

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